

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/563,463  
Applicant : Kimoon KIM, *et al.*  
Filed : January 5, 2006  
TC/A.U. : 1639  
Examiner : Christopher M. Gross

Docket No. : 1751-393  
Customer No. : 06449  
Confirmation No. : 1347

**DECLARATION**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

We, Kimoon Kim, Jin Koo Kang, Woo Seong Jeon, Sang Yong Jon, Selvapalam Narayanan, Dong Hyun Oh and Kangkyun Baek, declare as follows:

1. That Kimoon Kim, Jin Koo Kang, Woo Seong Jeon, Sang Yong Jon, Selvapalam Narayanan, Dong Hyun Oh and Kangkyun Baek are the inventors of the subject matter described and claimed in the United States Patent Application Serial No. 10/563,463, filed on January 5, 2006, entitled "Cucurbituril derivative-bonded solid substrate and biochip using the same."

2. That Sang Yong Jon, Narayanan Selvapalam<sup>1</sup>, Dong Hyun Oh, Jin-Koo Kang, Soo-Young Kim, Young Jin Jeon, Jae Wook Lee and Kimoon Kim are listed as the authors of *Facile Synthesis of Cucurbit[n]uril Derivatives via Direct*

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<sup>1</sup> The author "Narayanan Selvapalam" is actually Selvapalam Narayanan. The article mistakenly printed his last name first.

*Functionalization: Expanding Utilization of Cucurbit[n]uril.*, Journal of American Chemical Society, Vol. 125, pp. 10186-10187, June 6, 2003 ("the JACS article").

3. That all subject matter found in the JACS article was derived from the named inventors of the 10/563,463 patent application.

4. The three authors of the JACS article who are not listed as inventors in the United States Patent Application Serial No. 10/563,463, Soo-Young Kim, Young Jin Jeon and Jae Wook Lee, did not make any inventive contribution to the subject matter claimed in Application Serial No. 10/563,463.

5. The undersigned further declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

by

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Kimoon Kim

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Date

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Jin Koo Kang

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Date

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Woo Seong Jeon

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Date

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Sang Yong Jon	Date
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Selvapalam Narayanan	Date
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Dong Hyun Oh	Date
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Kangkyun Baek	Date
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